



Atty. Dkt. No. AMAT/5908.Y1/CPI/ALUMINUM/PJS

In re Application of:  
Wang, et al.


Group Art Unit: 2125

**Examiner: Kidest Bahta**

For: Semiconductor Wafer  
Preheating

CERTIFICATE OF MAILING  
37 CFR 1.8

I hereby certify that this correspondence is being deposited on  
8/26, 2005 with the United States Postal Service as  
First Class Mail in an envelope addressed to: Mail Stop  
Amendment, Commissioner for Patents, P.O. Box 1450,  
Alexandria, VA 22313-1450.

8/26/05   
Date Signature

Dear Sir:

In response to the Office Action dated May 26, 2005, having a shortened statutory period for response set to expire on August 26, 2005, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicant believes that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/AMAT/5908.Y1/CPI/ALUMINUM/PJS, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

**The Pending Claims** are listed beginning on page 2 of this paper. **Remarks** begin on page 6 of this paper.